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1. Objective

• Proven embedded systems engineer looking to transition into Machine Learning in process and business automation, utilizing CV, NLP or DL. End-to-end skills in problem specification, system design, ethical considerations, data collection and wrangling, modeling, evaluation, deployment and monitoring.

2. Certifications

- FourthBrain: Machine Learning Engineer 🔗
- TensorFlow.org: TensorFlow Developer 🔗
- AWS: Certified Machine Learning Specialty 🔗
- AWS: Certified Cloud Practitioner 🔗
- DeepLearning.AI (Specializations):
- \circ Deep Learning 🔗 \circ TensorFlow Developer \oslash \circ TensorFlow Advanced Techniques \oslash

3. Education

UC Berkeley: B.S. Electrical Engineering and Computer Science

4. Projects

- Semi-Supervised Methods on Medical Datasets: Fully supervised approaches need large, densely annotated dataset. Utilize Self and Semi-Supervised Learning with Knowledge Distillation on pediatric pneumonia X-Rays to significantly reduce the need for fully labeled data. REST API Web-App container deployed on GCP Cloud Run. [TensorFlow, SimCLR, FixMatch, FastAPI, Bootstrap, Docker]
- Identifying Cancer using Computational Histopathology: Evaluate different machine-learning algorithms for identifying metastatic cancer in small image patches taken from larger digital pathology scans. Understand how traditional hand-engineered Computer Vision features compare against Deep Learning's automatic feature-extraction. [SK-Learn, SK-Image, TensorFlow, Dask, TPOT, PyOD] &

4. Experience

- Machine Learning Student (+ Self-Study): FourthBrain (CA), 08/2021 Present
 - Andrew Ng's AI Fund backed 16-wk bootcamp for students with a professional software background. Engineers apply machine learning and deep learning methods with the goal of deploying end-to-end, scalable and production-ready solutions. Projects vetted by subject-matter experts.
 - Working in a 3-persons team, our CV/DL capstone project won a FourthBrain Top Project Award.
- Embedded Systems Engineer: Kernel (CA), 07/2020 08/2021
 - Co-designed embedded platform for world's first wearable full-head TD-fNIRS (Time-Domain functional Near-IR Spectroscopy) brain neuroimaging appliance. Miniaturize from rack-mounted to head-mounted system. Validated power delivery and data aggregation pipelines. Wrote bringup, diagnostics and production testing firmware. Semiconductor supply-chain risk planning and mitigation.

- Principal Hardware Engineer: Quanergy (CA), 09/2018 06/2020
 - Complete redesign of next-gen solid-state LiDAR sensor for reliability, cost and form-factor. Redesign and characterization of ultra-short pulsed laser-driver with improved performance. Support new silicon bring-up. Maintain and improve Python/PyQt tools for optoelectronics calibration, data visualization, test automation and data-collection. Develop new algorithms for weak-signal detection.
- Systems Hardware Engineer: Google (CA), 08/2017 05/2018
 - Lead-EE on Stadia wireless streaming game-controller. Designed for cost, latency and low-power, fully-functional from first build. Developed ambient sensor on Nest Hub smart-display assistant.
- Principal Hardware Engr. / Firmware Engr: GoPro (CA) , 02/2012 06/2017
 - API design and coding of Java Aerial SDK for direct control of UAV via smartphone. Launched Camera Hardware SDK for direct control of GoPro cameras by third-party integrators.
 - Lead-EE on Karma (GoPro's first UAV), and three generations of Hero digital cameras. 3rd EE hired at GoPro. End-to-end CE product development cycle Architecture and hardware/firmware-interface specification, components selection, schematics and layout, prototyping, performance evaluation, flight and safety testing, design validation, test plan, compliance certification and yield improvement. EE / ME / FW integration and troubleshooting, ODM liaison, DFM / BOM / ECO reviews.
- Sr. Hardware Engineer: NaturalPoint (OR), 01/2008 11/2011
 - Responsible for board hardware, firmware and FPGA (Altera Cyclone & Xilinx Spartan) design of USB and Ethernet(PoE) connected IR Motion-Capture camera systems. Complete product line refresh and new products introduction. Develop digital video-processing algorithms and custom IP in Verilog.

5. ML Skills

- **Libraries:** TensorFlow, Keras, PyTorch, Hugging Face, Spacy, OpenCV, SK-Learn, SK-Image, SciPy, Numpy, Pandas, Matplotlib, HDF5, TFRecord, BS4, FastAPI, Pydantic
- Concepts: Loss-Funcs, Metrics, Bias / Variance, Regularization, Backpropagation, Gradient Descent,
 Optimizers, Skip-Conn / Chain-Rule, Feature Engr, Dimensionality Reduction, HP Tuning, Ensembling,
 Self-Supervised Learning, Distillation, Attention, Error / Ceiling Analysis, Transfer Learning, Ethical AI
- ML: LinR / LogR, SVM, Bagging / Boosting, Anomaly Detection, Clustering, Label-Prop, Zero-Shot
- Sequence Models: RNN, LSTM, WaveNet, Transformers, Language Models, Beam Search, Sampling
- Vision Models: CNN, GAN, U-Net, YOLO, ResNet, Siamese Net, Feat Extractors, Autoencoders
- NLP: Token'tion, TF-IDF, Word2Vec, Embeddings, Lemma'tion, Normal'tion, NER, Similarity Search
- **CV**: Point / Morph / LSIS Ops, Moments, Hist EQ / Otsu, NLM, Non- / Linear Filters, Noise-Est / Weiner, Edge / Line & Shape (Hough) / Corner Detection, LBP / HOG / Haar / SIFT Features, Snakes / Boundaries, Segmentation / GrabCut, Compress Sense / Sparse Repr, DCT / Coding / Quantization

6. CS Skills

- Languages: Python, SQL (basics), Java, C, Assembly
- ISRs, Concurrency, Object-Oriented Programming, Data Structures, Design Patterns, Version Control
- Embedded Systems SDKs (e.g. STM32CubeMX), Multithreaded RTOS (e.g. FreeRTOS), Android Development, Networking Protocols (e.g. 802.3, ARP, DHCP, IP, UDP, TCP, HTTP)

7. Publications

• Feature Engineering for Machine Learning: Part I – Data Preprocessing, Part II – Feature Generation